IPC ASSOCIATION CONNI	Material Comp © Copyright 2005. Il international and Par	Material Composition Declaration © Copyright 2005. IPC, Bannockburn, Illinois. All rights reserved under both international and Pan-American copyright conventions.				This document is a declaration of the substances within the manufacturer listed item. Note: if the item is an assembly with lower level parts, the declaration encompasses all lower level materials for which the manufacturer has engineering responsibility.									
752-21.1		IPC Web Site for Information on IPC-1752 Standard Form Type http://www.ipc.org/IPC-175x Distribute				*	Declaration Class * Class 6 - RoHS Yes/No, Homogeneous Mater					ials and Mfg Information			
upplier Info										,					
Company name* Company unique ID			que ID		Unique ID Authority				Response Date*						
nsemi										2025-07-	2025-07-08				
Contact Name			Title - Contact			I	Phone - Contact*			Email - Contact*					
Product-Env-St	Stewards		Product Enviro Compliance				NA				Product-Env-Stewards@onsemi.com				
uthorized Rep	presentative*	Title - Representative			I	Phone - Representative*			Email - Representative*						
Product-Env-St	Stewards	Product Envir	Product Enviro Compliance			NA			Product-Env-Stewards@onsemi.com						
Requ	Requester Item Number Mfr		Number Mfr Item Name			Effective Date	e Versi	ion	Manufacturing Site	V	Veight*	UOM	Unit Type		
		ASX344A A0-DRB		VGA 1/4 SOC			2025-07-08			MY5	1	80.8	mg	Each	
Ianufacturi	ing Proccess Informa	tion													
Terminal Plating / Grid Array Material Terminal Base Alloy			Alloy	J-STD-020 MS	L Rating	Peak Pro	cess Bod	y Temperatu	re Max Time at Peak	Temperatu	ire Numb	per of Reflow Cyc	eles		
SnAgCu		CU Alloy 3			260 C		C 30		seconds 3						
omments															
TTENTION: 1	MSL 3 Rated item require	s Bake and D	ry Pack (after	electrical test)											
or more inform	mation regarding material	composition 1	please refer to	page 3											

RoHS Material Composition Declaration			Declaration Type *	Detail	led					
Directive 2015/863/EU amending RoHS Directive 2011/65/EU RoHS Definition: Quantity limit of 0.01% by mass (100 PPM) in homogeneous material for Cadmium and quantity limit of 0.1% by mass (1000 PPM) in homogeneous material for Cadmium and quantity limit of 0.1% by mass (1000 PPM) in homogeneous material for: Lead (Pb), Mercury (Hg), Hexavalent Chromium (Cr6+), Polybrominated Biphenyls (PBB), Polybrominated Diphenyl Ethers (PBDE), and Bis(2-ethylhexyl) phthalate (DEHP), Benzyl-butyl phthalate (BBP), Dibutyl phthalate (DBP), Diisobutyl phthalate (DIBP).										
Please indicate whether any homogeneous material (as defined by the RoHS Directive, EU 2011/65/EU and implemented by the laws of the European Union member states) of the part identified on this form contains lead, mercury, cadmium, hexavalentchromium, polybrominated biphenyls and/or polybrominated diphenyl ethers (each a "RoHS restricted substance") in excess of the applicable quantity limit identified above. If a homogeneous material within the part contains a RoHS restricted substance inexcess of an applicable quantity limit, please indicate below which, if any, RoHS exemption you believe may apply. If the part is an assembly with lower level components, the declaration shall encompass all such components. Supplier certifies that it gathered the information is true and correct to the best of its knowledge and belief, as of the date that Supplier completes this form. Supplier acknowledges that Company will rely on this certification in determining the compliance of its products with European Union member state laws that implement the RoHS Directive. Company acknowledges that Supplier may have relied on information provided by others in completing this form, and that Supplier may not have independently verified such information. However, in situations where Supplier have provided certifications regarding their contributions to the part, and those certifications are at least as comprehensive as the certification in this paragraph. If the Company and the Supplier enter into a written agreement with respect to the identified part, the terms and conditions of that agreement, including any warranty rights and/or remedies provided as part of that agreement, will be the sole and exclusivesource of the Supplier's Standard Terms and Conditions of Sale applicable to such part shall apply.										
RoHS Declaration * 1 - Item	(s) does not contain RoHS restricted substa	ances per the definition above	Supplier Ac	ceptance *	Accepted					
Exemption: If the declared item does not applicable exemptions.	contain RoHS restricted substances per	the definition above except for defined Ro	oHS exemptions, then select the corresponding	response in the R	oHS Declaration above and choose all					
Exemption List Version	EL-2011/534/EU									
Declaration Signature										
Instructional Complete all of the required	fields on all neggs of this form. Calcut th		a duan dawn. This will display the signature on	a Digitally sign	the declaration (if recruired by the					
Instructions: Complete all of the required Requester) and click on Submit Form to			e drop-down. This will display the signature ar	ea. Digitally sign	the declaration (if required by the					

Homogeneous Material Composition Declaration for Electronic Products

SubItem Instructions: The presence of any JIG Level A or B substances must be declared. [1] indicate the subpart in which the substance is located, [2] provide a description of the homogeneous material [3], enter the weight of the homogeneous material.

Substance Instructions: [A] select the Level (JIG A, JIG B, Requester or Supplier) [B] select the substance category (JIG or Requester) or enter a value (Supplier). [C] select the substance (JIG) or enter the substance and CAS (Other). [D] select a RoHS exemption, if applicable [E] enter the weight of the substance or the PPM concentration [F] Optionally enter the positive (+) and negative (-) tolerance in percent (Note: percent tolerance values are expected to cover a 3 sigma range of distribution unless otherwise noted).

Homogeneous Material	Weight	Unit of Measure	Level	Substance	CAS	Exempt	Weight	Unit of Measure
Die	22.05	mg		Misc.	proprietary data		0.0838	mg
			Supplier	Silicon (Si)	7440-21-3		21.7479	mg
			Supplier	Aluminum (Al)	7429-90-5		0.2183	mg
Die Attach	0.97	mg	Supplier	Bisphenol A_Epichlorohydrin Polymer	25068-38-6		0.3638	mg
			Supplier	Ethylene Glycol	107-21-1		0.0097	mg
			Supplier	Sulfonium (Thiodi-4,1-phenylene)	89452-37-9		0.0291	mg
			Supplier	Modified Silicon Dioxide (SiO2)	67762-90-7		0.2037	mg
			Supplier	Formaldehyde Polymer	9003-36-5		0.3638	mg
Imaging Lens	34.06	mg	Supplier	Titanium Dioxide (TiO2)	13463-67-7		1.7926	mg
			Supplier	Sodium Monoxide (Na2O)	1313-59-3		1.7926	mg
			Supplier	Boron Trioxide (B2O3)	1303-86-2		0.1795	mg
			Supplier	Zinc Monoxide (ZnO)	1314-13-2		1.7926	mg
			Supplier	Aluminum Trioxide (Al2O3)	1344-28-1		1.7926	mg
			Supplier	Potassium Monoxide (K2O)	12136-45-7		1.7926	mg
			Supplier	Silica Crystalline (SiO2)	14808-60-7		24.9176	mg
Lid Attach	1.05	mg	Supplier	Bisphenol A_Epichlorohydrin Polymer	25068-38-6		0.315	mg
			Supplier	Filler (SiO2)	68909-20-6		0.0525	mg
			Supplier	Epoxy Prepolymer	Proprietary Data		0.3412	mg
			Supplier	Formaldehyde Polymer	9003-36-5		0.3412	mg
Mold Compound-Black	40.48	mg		Phenolic Resin	proprietary data		6.072	mg
			Supplier	Oxirane	39817-09-9		6.072	mg
			Supplier	1,4-Bis(2,3-epoxypropoxy)butane	2425-79-8		1.2144	mg
			Supplier	Carbon Black (C)	1333-86-4		0.4048	mg
			Supplier	Fused Silica (SiO2)	60676-86-0		25.9072	mg
			Supplier	Silica Crystalline (SiO2)	14808-60-7		0.8096	mg
Solder Ball	30.61	mg	Supplier	Silver (Ag)	7440-22-4		0.9183	mg
			Supplier	Tin (Sn)	7440-31-5		29.5387	mg
			Supplier	Copper (Cu)	7440-50-8		0.1531	mg
Substrate and Solder Mask	51.12	mg	Supplier	Bis(3-ethyl-5-methyl-4-maleimidophenyl)methane	105391-33-1		0.5725	mg
			Supplier	Fiber Glass (SiO2)	65997-17-3		6.6252	mg
			Supplier	Zinc (Zn)	7440-66-6		0.0767	mg

			Supplier	Inorganic Filler of Solder Mask_Talc (Mg3Si4O10(OH)2)	14807-96-6	1.1911	mg
			Supplier	Cyanic acid (1-methylethylidene)di-4,1- phenylene ester homopolymer	25722-66-1	0.5725	mg
			Supplier	Silica Amorphous (SiO2)	7631-86-9	0.2965	mg
			Supplier	Chromium (Cr)	7440-47-3	0.0051	mg
			Supplier	Acetophenone Derivative	Proprietary Data	1.7841	mg
			Supplier	Carbon Black (C)	1333-86-4	0.2965	mg
			Supplier	2,4-Diethyl-9H-thioxanthen-9-one (DETX)	82799-44-8	0.2965	mg
			Supplier	Aluminum Hydroxide (Al(OH)3)	21645-51-2	6.1344	mg
			В	Nickel (Ni)	7440-02-0	0.7208	mg
			Supplier	Gold (Au)	7440-57-5	0.0256	mg
			Supplier	Solvent Naphtha (Solvent oil)	64742-94-5	3.5733	mg
			Supplier	Formaldehyde Polymer	9003-36-5	0.5725	mg
			Supplier	Copper (Cu)	7440-50-8	19.1496	mg
			Supplier	Barium Sulfate (BaSO4)	7727-43-7	9.2272	mg
Wire Bond - Au	0.46	mg	Supplier	Gold (Au)	7440-57-5	0.46	mg